

1 2 3 4 5 6 7 8

更改 REV	设计内容 MODIFICATION	日期 DATE	制图 DRAW	核准 APPROVE
A	图面发行	2012/10/29	JDL	Oscar

NOTES:

MATERIAL:

- 1. HOUSING MATERIAL :GLASS FILLED POLYESTER(UL94V-0).
- 2. CONTACT MATERIAL :PHOSPHOR BRONZE  $\phi$ 0.46mm (C5100).

- 3. PLATING :GOLD PLATING OVER NICKEL.
- 4. SHIELD :COPPER ALLOY 0.20mm THICKNESS PLATING NI.

ELECTRICAL:

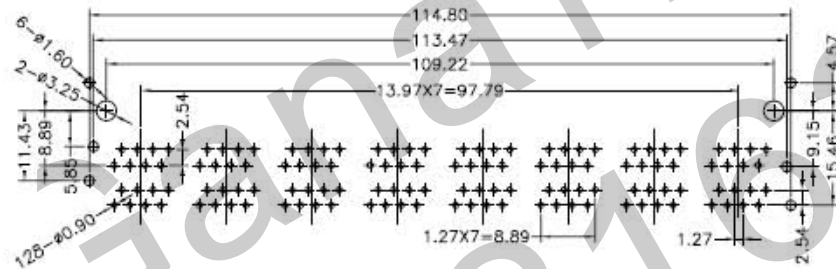
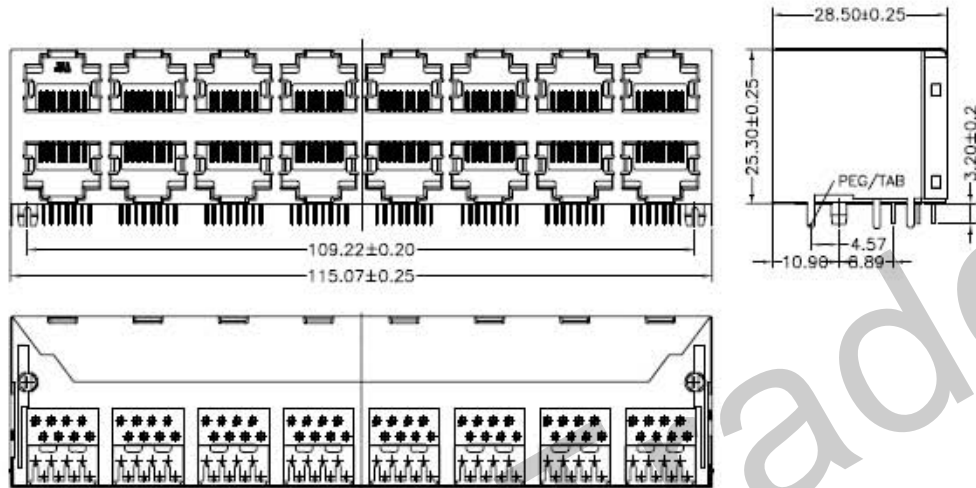
- 1. VOLTAGE RATING :125 VAC RMS.
- 2. CURRENT RATING :1.5 AMP.
- 3. CONTACT RESISTANCE :50 MILLIOHMS MAX.
- 4. INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC.
- 5. DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz, 1MIN.

MECHANICAL:

- 1. DURRABILITY :750 CYCLES MIN.
- 2. PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

- 1. STORAGE : -40°C TO +85°C.
  - 2. OPERATION : 0°C TO 70°C.
- MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F.



PC Board Layout

QC : Inspection Item CPK : Cp/Cpk and SPC Control Item	DIMENSION IN mm [Inch]		HDC 有限公司			
	TOLERANCE UNLESS OTHERWISE SPECIFIED		文件号 FILE NO.	图号 DWG NO. GRJ-H7234		
	.X± 0.20	X.*± 1*	名称 TITLE			
	.XX± 0.15	.X.*± 0.5*	59A 2X8 8PBC PCB JACK&SHIELDED W/D EMI FINGER SIDE ENTRY, ROUND PIN			
.XXX± 0.075		核准 APPROVE	制图 DRAW Oscar	审核 CHECK	比例 SCALE 1:1	张数 SHEET 1 / 1
			图法 PROJ	图幅 SIZE A3	更改 REV A	

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